

HV start-up DCM/QR flyback controller with integrated DCM/QR PFC controller

Rev. 3 — 24 August 2012

Product data sheet

1. General description

The TEA1753LT is the third generation of green Switched Mode Power Supply (SMPS) controller ICs. The TEA1753LT combines a controller for Power Factor Correction (PFC) and a flyback controller. Its high level of integration allows the design of a cost-effective power supply with a very low number of external components.

The special built-in green functions provide high efficiency at all power levels. This efficiency applies to quasi-resonant operation at high-power levels, quasi-resonant operation with valley skipping, as well as to reduced frequency operation at lower power levels. At low-power levels, the PFC switches off to maintain high efficiency.

During low-power conditions, the flyback controller switches to frequency reduction mode and limits the peak current to an adjustable minimum value. This mode ensures high efficiency at low-power and good standby power performance while minimizing audible noise from the transformer.

The controller can be switched to the power-down mode for no-load operation. In this mode, the controller is shut down for very low standby power applications

The TEA1753LT is a Multi-Chip Module (MCM), containing 2 chips. The proprietary high-voltage BCD800 process which makes direct start-up possible from the rectified universal mains voltage in an effective and green way. The second low voltage Silicon On Insulator (SOI) is used for accurate, high-speed protection functions and control.

The TEA1753LT enables the design of highly efficient and reliable supplies with power requirements of up to 250 W using a minimum number of external components.

Remark: All values provided throughout the running text, are typical values unless otherwise stated.



HV start-up flyback controller with integrated PFC controller

2. Features and benefits

2.1 Distinctive features

- Integrated PFC and flyback controller
- Universal mains supply operation (70 V (AC) to 276 V (AC))
- Dual-boost PFC with accurate maximum output voltage (NXP patented)
- High level of integration, resulting in a very low external component count and a cost-effective design
- Adjustable PFC switch-off delay

2.2 Green features

- On-chip start-up current source
- Power down functionality for very low standby power

2.3 PFC green features

- Valley/zero voltage switching (ZVS) for minimum switching losses (NXP patented)
- Frequency limitation to reduce switching losses
- PFC is switched off when a low load is detected at the flyback output

2.4 Flyback green features

- Valley switching for minimum switching losses (NXP patented)
- Frequency reduction with adjustable minimum peak current at low-power operation to maintain high efficiency at low output power levels

2.5 Protection features

- Safe restart mode for system fault conditions
- Continuous mode protection with demagnetization detection for both converters (NXP patented)
- UnderVoltage Protection (UVP) (foldback during overload)
- Accurate OverVoltage Protection (OVP) for both converters (adjustable for flyback converter)
- Mains voltage independent OverPower Protection (OPP)
- Open control loop protection for both converters. The open-loop protection on the flyback converter is latched
- OverTemperature Protection (OTP)
- Low and adjustable OverCurrent Protection (OCP) trip level for both converters
- General-purpose latched protection input for system OverTemperature Protection (OTP) for example

3. Applications

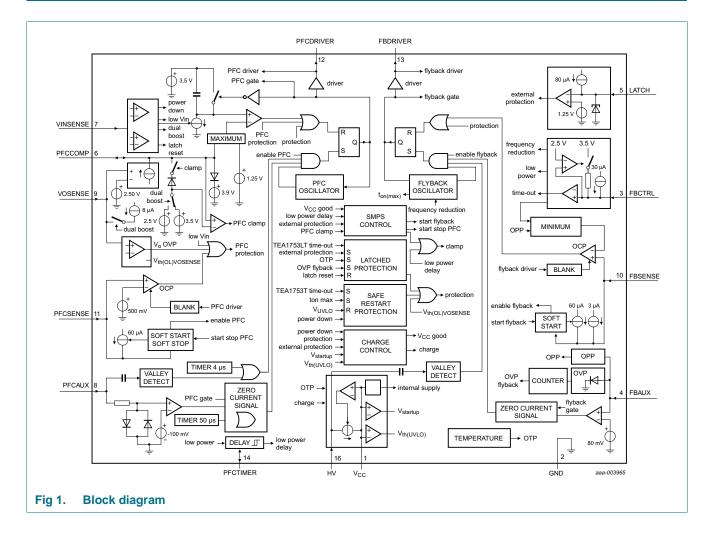
The device is used in all applications requiring an efficient and cost-effective power supply solution up to 250 W. Notebook adapters, in particular, benefit from the high level of integration

4. Ordering information

Type number	er Package		
	Name	Description	Version
TEA1753LT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1

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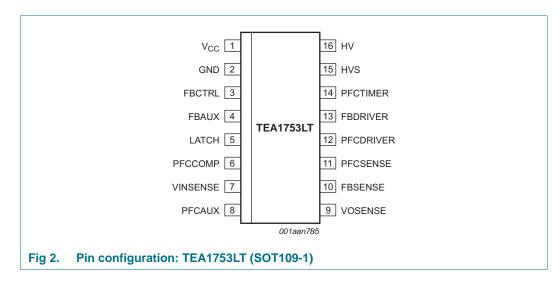
5. Block diagram



TEA1753LT Product data sheet

6. Pinning information

6.1 Pinning



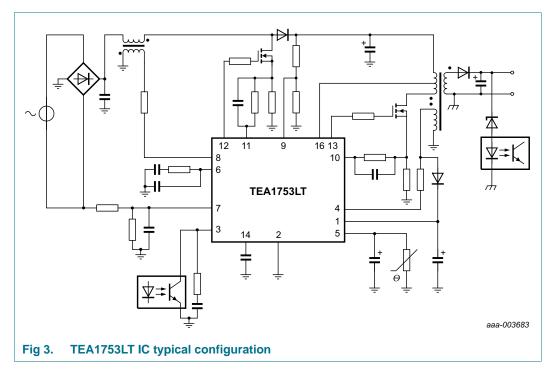
6.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
V _{CC}	1	supply voltage
GND	2	ground
FBCTRL	3	flyback control input
FBAUX	4	auxiliary winding input for demagnetization timing and flyback OVP
LATCH	5	general-purpose protection input
PFCCOM	P 6	frequency compensation pin for PFC
VINSENS	E 7	mains voltage sense input
PFCAUX	8	auxiliary winding input for demagnetization timing for PFC
VOSENSE	E 9	sense input for PFC output voltage
FBSENSE	10	flyback current sense input
PFCSENS	SE 11	PFC current sense input
PFCDRIV	ER 12	PFC gate-driver output
FBDRIVE	R 13	flyback gate-driver output
PFCTIME	R 14	delay timer pin for PFC on/off control
HVS	15	high-voltage safety spacer, not connected
HV	16	high-voltage start-up/ flyback valley sensing

7. Functional description

7.1 General control

The TEA1753LT contains a controller for a power factor correction circuit as well as a controller for a flyback circuit. A typical configuration is shown in Figure 3.



7.1.1 Start-up and UnderVoltage LockOut (UVLO)

Initially the capacitor on the V_{CC} pin is charged from the high-voltage mains using the HV pin.

When V_{CC} is less than V_{trip} , the charge current is low. This low current protects the IC if the V_{CC} pin is shorted to ground. To ensure a short start-up time, the charge current above V_{trip} is increased until V_{CC} reaches $V_{th(UVLO)}$. When V_{CC} is between $V_{th(UVLO)}$ and $V_{startup}$, the charge current returns to low to ensure a low safe restart duty cycle during fault conditions.

The control logic activates the internal circuitry and switches off the HV charge current when the voltage on pin V_{CC} passes the V_{startup} level. First, the LATCH pin current source is activated and the soft-start capacitors on the PFCSENSE and FBSENSE pins are charged. Also the clamp circuit on the PFCCOMP pin is activated.

The PFC circuit is activated when the following conditions are met:

- the LATCH pin voltage exceeds the $V_{en(LATCH)}$ voltage
- the PFCCOMP pin voltage reaches the $V_{\text{en}(\text{PFCCOMP})}$ voltage
- the soft-start capacitor on the PFCSENSE pin is charged

If the soft start capacitor on the FBSENSE pin is charged, the flyback converter is also activated. The flyback converter output voltage is then regulated to its nominal output voltage. The auxiliary winding of the flyback converter takes over the IC supply. See Figure 4.

If during start-up the LATCH pin does not reach the $V_{en(LATCH)}$ level before V_{CC} reaches $V_{th(UVLO)}$, it is deactivated. The charge current is then switched on again.

When the flyback converter starts, V_{FBCTRL} is monitored. If this output voltage does not reach its intended regulation level within a specified time, the voltage on the FBCTRL pin reaches the $V_{to(FBCTRL)}$ level. An error is then assumed and a latched protection is initiated.

When one of the protection functions is activated, both converters stop switching and the V_{CC} voltage drops to $V_{th(UVLO)}$. A latched protection recharges capacitor C_{VCC} using the HV pin, but does not restart the converters. To provide safe restart protection, the capacitor is recharged using the HV pin and the device restarts (see block diagram, Figure 1).

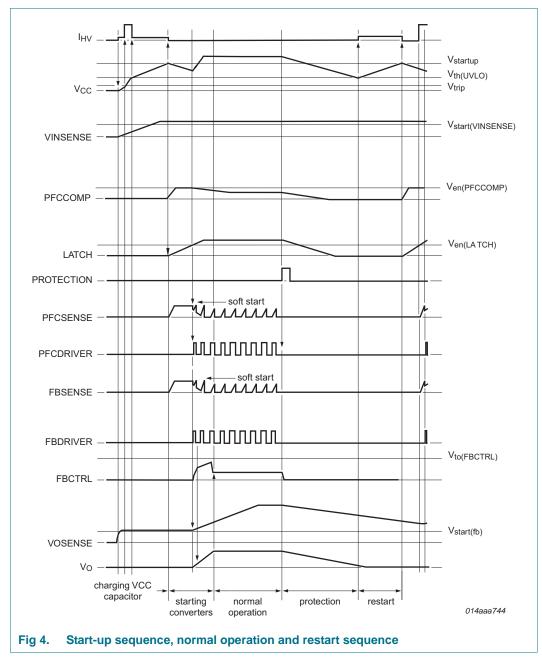
If OVP of the PFC circuit (V_{VOSENSE} > V_{OVP(VOSENSE)}) occurs, the PFC controller stops switching until the VOSENSE pin voltage drops to less than V_{OVP(VOSENSE}). If a mains undervoltage is detected, V_{VINSENSE} < V_{stop(VINSENSE}), the PFC controller stops switching until V_{VINSENSE} > V_{start(VINSENSE}) again.

When the voltage on the V_{CC} pin drops below the undervoltage lockout level, both controllers stop switching and re-enter the safe restart mode. In the safe restart mode, the driver outputs are disabled and the V_{CC} pin voltage is recharged using the HV pin.

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7.1.2 Power down

The power-down mode is activated for very low standby power applications by pulling the VINSENSE pin below the V_{th(pd)} level. The TEA1753LT stops switching and the safe restart protection is activated. The high-voltage start-up current source is also disabled during power-down, so the TEA1753LT does not restart until the VINSENSE pin voltage is raised again. During power down all internal circuitry is disabled except for a voltage detection circuit on the VINSENSE pin. This circuit is supplied by the HV pin and draws 16 μ A from the HV pin for biasing.

If the VINSENSE pin is pulled low, a latched protection is also reset. (see Section 7.1.5)

7.1.3 Supply management

All internal reference voltages are derived from a temperature compensated and trimmed on-chip band gap circuit. Internal reference currents are derived from a temperature compensated and trimmed on-chip current reference circuit.

7.1.4 Latch input

The LATCH pin is a general-purpose input pin, which is used to switch off both converters. The pin sources a current $I_{O(LATCH)}$ of 80 μ A. Switching is stopped as soon as the voltage on this pin drops below 1.25 V.

At initial start-up, switching is inhibited until the capacitor on the LATCH pin is charged above 1.35 V. No internal filtering is done on this pin. An internal Zener clamp of 2.9 V protects this pin from excessive voltages.

7.1.5 Fast latch reset

In a typical application, the mains is interrupted briefly to reset the latched protection. The PFC bus capacitor, C_{bus} , does not have to discharge for this latched protection to reset.

When the VINSENSE voltage drops below 750 mV and is then raised to 870 mV, the latched protection is reset.

The latched protection is also reset by removing the voltage on the V_{CC} and HV pins.

7.1.6 Overtemperature protection

An accurate internal temperature protection is provided in the circuit. When the junction temperature exceeds the thermal shut-down temperature, the IC stops switching. As long as OTP is active, the capacitor C_{VCC} is not recharged from the HV mains. If the V_{CC} supply voltage is not sufficient, the OTP circuit is supplied from the HV pin.

OTP is a latched protection. It is reset by removing the voltage on the V_{CC} and HV pins or by the fast latch reset function. (See <u>Section 7.1.5</u>)

7.2 Power factor correction circuit

The power factor correction circuit operates in quasi-resonant or Discontinuous Conduction Mode (CDM) with valley switching. The next primary stroke is only started when the previous secondary stroke has ended and the voltage across the PFC MOSFET has reached a minimum value. V_{PFCAUX} is used to detect transformer demagnetization and the minimum voltage across the external PFC MOSFET switch.

7.2.1 ton control

The power factor correction circuit is operated in t_{on} control. The resulting mains harmonic reduction is well within the class-D requirements.

7.2.2 Valley switching and demagnetization (PFCAUX pin)

The PFC MOSFET is switched on after the transformer is demagnetized. Internal circuitry connected to the PFCAUX pin detects the end of the secondary stroke. It also detects the voltage across the PFC MOSFET. To reduce switching losses and electromagnetic Interference (EMI) (valley switching), the next stroke is started if the voltage across the PFC MOSFET is at its minimum.

If a demagnetization signal is not detected on the PFCAUX pin, the controller generates a Zero Current Signal (ZCS), 50 μ s after the last PFCGATE signal.

If a valley signal is not detected on the PFCAUX pin, the controller generates a valley signal 4 μ s after demagnetization is detected.

To protect the internal circuitry during lightning events, for example, add a 5 k Ω series resistor to PFCAUX. To prevent incorrect switching due to external disturbance, place the resistor close to the IC on the printed-circuit board.

7.2.3 Frequency limitation

To optimize the transformer and minimize switching losses, the switching frequency is limited to $f_{sw(PFC)max}$. If the frequency for quasi-resonant operation is above the $f_{sw(PFC)max}$ limit, the system switches over to DCM. The PFC MOSFET is only switched on at a minimum voltage across the switch (valley switching).

7.2.4 Mains voltage compensation (VINSENSE pin)

The equation for the transfer function of a power factor corrector contains the square of the mains input voltage. In a typical application this results in a low bandwidth for low mains input voltages and a high bandwidth for high mains input voltages.

To compensate for the mains input voltage influence, TEA1753LT contains a correction circuit. The average input voltage is measured using the VINSENSE pin and the information is fed to an internal compensation circuit. Using this compensation, it is possible to keep the regulation loop bandwidth constant over the mains input range. This yields a fast transient response on load steps, while still complying with class-D MHR requirements.

In a typical application, a resistor and two capacitors on the PFCCOMP pin set the bandwidth of the regulation loop.

7.2.5 Soft start-up (PFCSENSE pin)

To prevent audible transformer noise at start-up or during hiccup, the soft-start function slowly increases the transformer peak current. This increase is achieved by inserting R_{SS1} and C_{SS1} between the PFCSENSE pin and current sense resistor R_{SENSE1} . An internal current source charges the capacitor to:

$$V_{PFCSENSE} = I_{start(soft)PFC} \times R_{SS1}$$

The voltage is limited to V_{start(soft)PFC}.

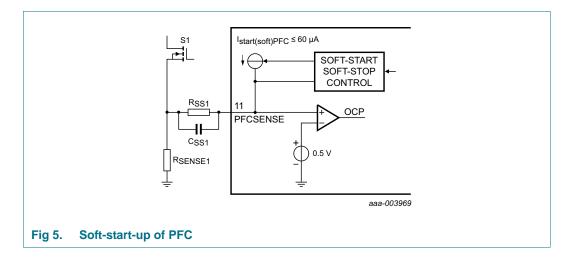
The start level and the time constant of the increasing primary current level is adjusted externally by changing the values of R_{SS1} and C_{SS1} .

$$\tau soft-start = 3 \times R_{SS1} \times C_{SS1}$$
(2)

The charging current I_{start(soft)PFC} flows as long as V_{PFCSENSE} is below 0.5 V. If V_{PFCSENSE} exceeds 0.5 V, the soft-start current source starts limiting current I_{start(soft)PFC}. When the PFC starts switching, the I_{start(soft)PFC} current source is switched off; see Figure 5.

(1)

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7.2.6 Low-power mode

When the output power of the flyback converter (see <u>Section 7.3</u>) is low, the flyback converter switches over to frequency modulation mode. When the maximum switching frequency of the flyback drops below 48 kHz, the power factor correction circuit is switched off to maintain high efficiency. Connect a capacitor to the PFCTIMER pin to delay switching off (see also Section 7.2.7).

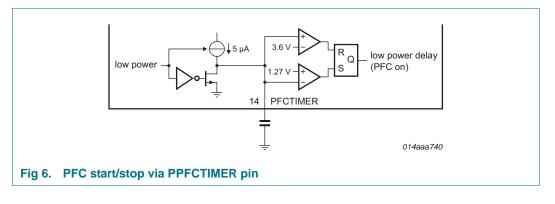
During low-power mode operation, the PFCCOMP pin is clamped to a minimum voltage of 3.5 V or 2.5 V and a maximum voltage of 3.9 V. The lower clamp voltage depends on the voltage on VINSENSE pin. This voltage limits the maximum power that is delivered when the PFC is switched on again. The upper clamp voltage ensures that the PFC returns from low-power mode to its normal regulation point in a limited time.

When the maximum switching frequency of the flyback converter exceeds 86 kHz, the power factor correction circuit restores normal operation.

7.2.7 PFC off delay (pin PFCTIMER)

When the flyback converter maximum frequency drops below 48 kHz, the PFC is switched off. The IC then outputs a 5 μ A current to the PFCTIMER pin. When the voltage on the PFCTIMER pin reaches 3.6 V, the PFC is switched off by performing a soft-stop.

When the flyback converter frequency exceeds 86 kHz, a switch discharges the PFCTIMER pin capacitor. When the voltage on the PCTIMER pin drops below 1.27 V, the PFC is switched on (see Figure 6).



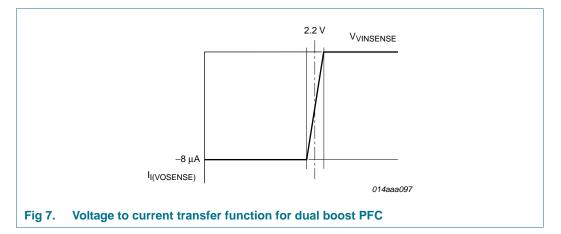
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7.2.8 Dual-boost PFC

The mains input voltage modulates the PFC output voltage. The mains input voltage is measured using the VINSENSE pin. If the voltage on the VINSENSE pin drops below 2.2 V, the current is sourced from the VOSENSE pin. To ensure the stable switch-over, a 200 mV transition region is inserted around the 2.2 V, see Figure 7.

For low VINSENSE input voltages, the output current is 8 μ A. This output current, in combination with the resistors on the VOSENSE pin, sets the lower PFC output voltage level at low mains voltages. At high mains input voltages, the current is switched to zero. The PFC output voltage is then at its maximum. As this current is zero in this situation, it does not affect the accuracy of the PFC output voltage.

For proper switch-off, the VOSENSE current is switched to its maximum value of 8 μ A when the voltage on pin VOSENSE drops below 2.1 V.



7.2.9 Overcurrent protection (PFCSENSE pin)

The maximum peak current is limited cycle-by-cycle by sensing the voltage across an external sense resistor, R_{SENSE1} , on the source of the external MOSFET. The voltage is measured using the PFCSENSE pin.

7.2.10 Mains undervoltage lockout/brownout protection (VINSENSE pin)

To prevent the PFC from operating at very low mains input voltages, the voltage on the VINSENSE pin is continuously sensed. When the voltage on this pin drops below the $V_{stop(VINSENSE)}$ level, switching of the PFC is stopped.

7.2.11 Overvoltage protection (VOSENSE pin)

To prevent output overvoltage during load steps and mains transients, an overvoltage protection circuit is built in.

When the voltage on the VOSENSE pin exceeds the V_{ovp(VOSENSE)} level, switching of the power factor correction circuit is inhibited. Switching of the PFC recommences when the VOSENSE pin voltage drops below the V_{ovp(VOSENSE)} level again.

When the resistor between the VOSENSE pin and ground is open, the overvoltage protection is also triggered.

7.2.12 PFC open-loop protection (VOSENSE pin)

The power factor correction circuit does not start switching until the voltage on the VOSENSE pin is above the $V_{th(ol)(VOSENSE)}$ level. This feature protects the circuit from open-loop and VOSENSE short-circuit.

7.2.13 Driver (PFCDRIVER pin)

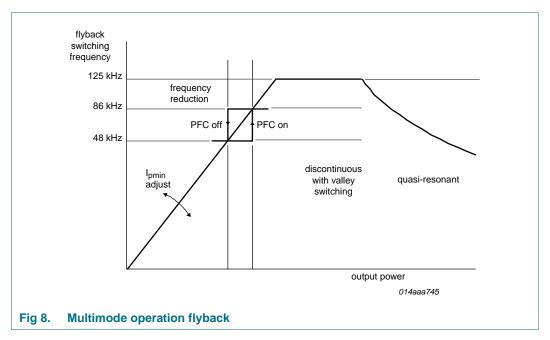
The driver circuit to the gate of the power MOSFET has a current sourcing capability of -500 mA and a current sink capability of 1.2 A. These capabilities permit fast turn-on and turn-off of the power MOSFET for efficient operation.

7.3 Flyback controller

The TEA1753LT includes a controller for a flyback converter. The flyback converter operates in quasi-resonant or DCM with valley switching. The auxiliary winding of the flyback transformer provides demagnetization detection and powers the IC after start-up.

7.3.1 Multimode operation

The TEA1753LT flyback controller operates in several modes; see Figure 8.



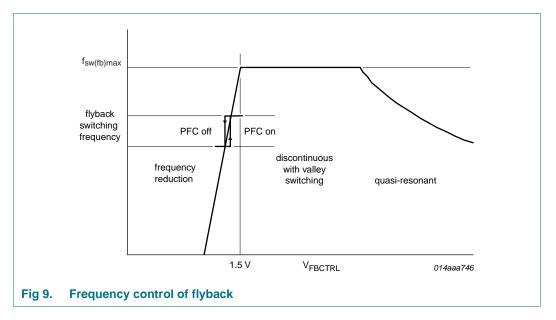
At high output power the converter switches to quasi-resonant mode. The next converter stroke starts after demagnetization of the transformer and detection of the valley. In quasi-resonant mode switching losses are minimized. This minimization is achieved by the converter only switching on when the voltage across the external MOSFET is at its minimum (see also Section 7.3.2).

To prevent high frequency operation at low loads, the maximum switching frequency is limited to 125 kHz. When the frequency limit is reached, the quasi-resonant operation changes to DCM with valley skipping. This mode limits the MOSFET switch-on losses and conducted EMI.

A Voltage Controlled Oscillator (VCO) controls the frequency at very low power and standby levels. The minimum frequency is reduced to zero. During frequency reduction mode, the primary peak current is kept at an adjustable minimal level to maintain a high efficiency. As the primary peak current is low in frequency reduction operation, no audible noise is noticeable at switching frequencies in the audible range. Valley switching is also active in this mode.

In frequency reduction mode, the PFC controller is switched off. The flyback maximum frequency changes linearly with the control voltage on the FBCTRL pin (see Figure 9). Hysteresis has been added for stable on and off switching of the PFC. At no-load operation, the switching frequency is reduced to (almost) zero.

The input voltage of the flyback converter and the capacitance on the drain node of the flyback power switch affect the frequency reduction slope. By choosing the proper compensation, the frequency reduction slope for high input voltages is chosen as the same as for low input voltages. This compensation yields an input voltage independent PFC switch-on and switch-off power level (see the application information in Section 11).



7.3.2 Valley switching (HV pin)

A new cycle starts when the external MOSFET is switched on. V_{FBSENSE} and V_{FBCTRL} determine the on-time. The MOSFET is then switched off and the secondary stroke starts. After the secondary stroke, the drain voltage shows an oscillation with a frequency of approximately:

$$f = \frac{1}{\left[2 \times \pi \times \sqrt{(L_p \times C_d)}\right]}$$
(3)

where L_p is the primary self-inductance of the flyback transformer and C_d is the capacitance on the drain node.

When the internal oscillator voltage is high and the secondary stroke ended, the circuit waits for the lowest drain voltage before starting a new primary stroke.

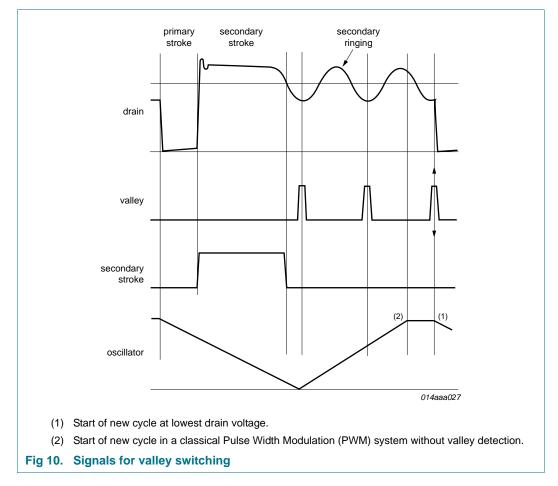
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<u>Figure 10</u> shows the drain voltage, valley signal, secondary stroke signal and the internal oscillator signal.

Valley switching allows high frequency operation as capacitive switching losses are reduced, see Equation 4. High frequency operation makes small and cost-effective magnetic components possible.

$$P = \frac{1}{2} \times C_d \times V^2 \times f \tag{4}$$



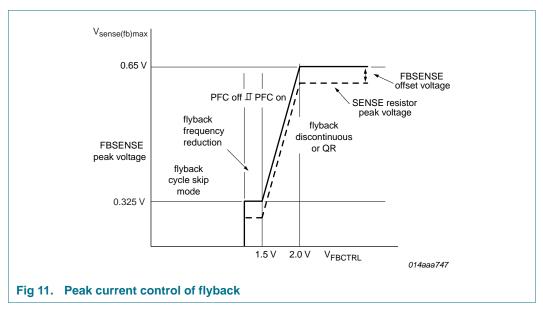
7.3.3 Current mode control (FBSENSE pin)

Current mode control is used for the flyback converter for its good line regulation.

The FBSENSE pin senses the primary current across an external resistor and compares it with an internal control voltage. The internal control voltage is proportional to the FBCTRL pin voltage, see <u>Figure 11</u>.

The FBSENSE pin outputs a current of 3 μ A. This current runs through the resistors from the FBSENSE pin to the sense resistor and creates an offset voltage. The minimum peak current of the flyback is adjusted using this offset voltage. Adjusting the minimum peak current level, changes the frequency reduction slope (see Figure 8).

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The driver output is latched in the logic, preventing multiple switch-on.

7.3.4 Demagnetization (FBAUX pin)

The system is always in QR or DCM. The internal oscillator does not start a new primary stroke until the previous secondary stroke has ended.

Demagnetization features a cycle-by-cycle output short-circuit protection by immediately lowering the frequency (longer off-time), thus reducing the power level.

Demagnetization recognition is suppressed during the first $t_{sup(xfmr_ring)}$ time of 2 µs. This suppression is necessary at low output voltages and at start-up. It is also required in applications where the transformer has a large leakage inductance.

If the FBAUX pin is open-circuit or not connected, a fault condition is assumed and the converter immediately stops. Operation restarts as soon as the fault condition is removed.

7.3.5 Flyback control/time-out (FBCTRL pin)

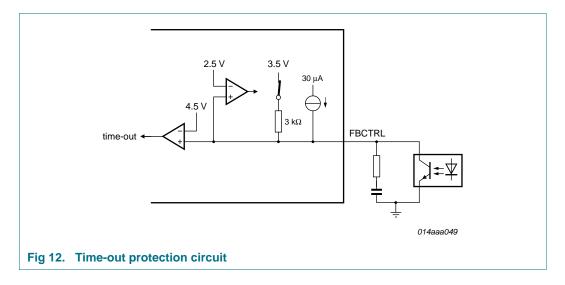
The FBCTRL pin is connected to an internal voltage source of 3.5 V using an internal resistor of 3 k Ω . When the voltage on this pin exceeds 2.5 V, the connection is disabled and the pin is biased with a small current. If the voltage on this pin exceeds 4.5 V, a fault is assumed, switching is stopped and a latched protection is activated.

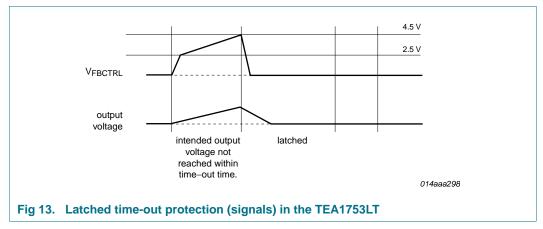
If a capacitor and a resistor are connected in series to this pin, a time-out function is created to protect against an open control loop. See Figure 12 and Figure 13. The time-out function is disabled by connecting a resistor (100 k Ω) to ground on the FBCTRL pin.

If the pin is short-circuited to ground, switching of the flyback controller is prevented.

During normal operating conditions, the converter regulates the output voltage. The voltage on the FBCTRL pin is then between 1.3 V for the minimum output power and 2 V for the maximum output power.

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7.3.6 Soft start-up (FBSENSE pin)

To prevent audible transformer noise during start-up, the soft-start function slowly increases the transformer peak current. This increase is achieved by inserting a resistor and a capacitor between pin 10 (FBSENSE) and the current sense resistor.

An internal current source charges the capacitor to:

$$V = I_{start(soft)fb} \times R_{SS2}$$

with a maximum of approximately 0.63 V.

The start level and the time constant of the increasing primary current level is adjusted externally by changing the values of R_{SS2} and C_{SS2} .

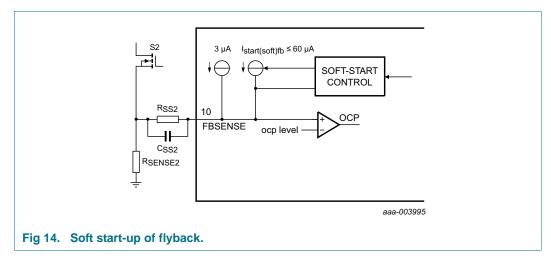
$$\tau soft-start = 3 \times R_{SSI} \times C_{SSI}$$
(6)

The soft-start current $I_{start(soft)fb}$ is switched on as soon as V_{CC} reaches $V_{startup}$. When $V_{FBSENSE}$ has reached 0.63 V, the flyback converter starts switching.

(5)

HV start-up flyback controller with integrated PFC controller

The charging current $I_{start(soft)(FB)}$ flows as long as $V_{FBSENSE}$ is less than approximately 0.63 V. If $V_{FBSENSE}$ exceeds 0.63 V, the soft start current source starts limiting the current. After the flyback converter has started, the soft-start current source is switched off.



7.3.7 Maximum on-time

The flyback controller limits the on-time of the external MOSFET to 40 μ s. When the on-time is longer than 40 μ s, the IC stops switching and enters the safe restart mode.

7.3.8 Overvoltage protection (FBAUX pin)

An output overvoltage protection is implemented in the GreenChip III series. In the TEA1753LT, the auxiliary voltage is sensed using the current flowing into the FBAUX pin during the secondary stroke. The auxiliary winding voltage is a well-defined replica of the output voltage. An internal filter averages voltage spikes.

An internal up-down counter prevents false OVP detection which occurs during ESD or lightning events. The internal counter counts up by one when the output voltage exceeds the OVP trip level within one switching cycle. The internal counter counts down by two when the output voltage has not exceeded the OVP trip level within one switching cycle. When the counter has reached eight, the IC assumes a true OVP, sets the latched protection and switches off both converters.

The converter only restarts after the OVP latch is reset. In a typical application, the internal latch is reset when the VINSENSE voltage drops below 750 mV and is then raised to 870 mV.

The latched protection is also reset by removing both the voltage on the VCC and HV pins.

The demagnetization resistor, R_{FBAUX} sets the output voltage $V_{o(\text{OVP})}$ at which the OVP function trips:

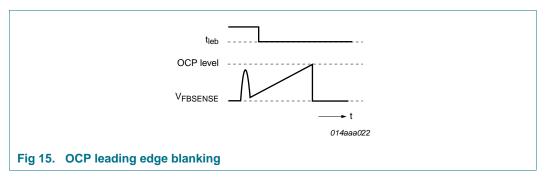
$$V_{o(OVP)} = \frac{N_s}{N_{aux}} (I_{ovp(FBAUX)} \times R_{FBAUX} + V_{clamp(FBAUX)})$$
(7)

where N_s is the number of secondary turns and N_{aux} is the number of auxiliary turns of the transformer. Current $I_{ovp(FBAUX)}$ is internally trimmed.

Accurate OVP detection is made possible by adjusting the value of $\mathsf{R}_{\mathsf{FBAUX}}$ to the turns ratio of the transformer.

7.3.9 Overcurrent protection (FBSENSE pin)

The primary peak current in the transformer is measured accurately cycle-by-cycle using the external sense resistor R_{sense2} . The OCP circuit limits $V_{FBSENSE}$ to a level set by V_{fbctrl} (see also <u>Section 7.3.3</u>). The OCP detection is suppressed during the leading-edge blanking period, t_{leb} , to prevent false triggering due to switch-on spikes.

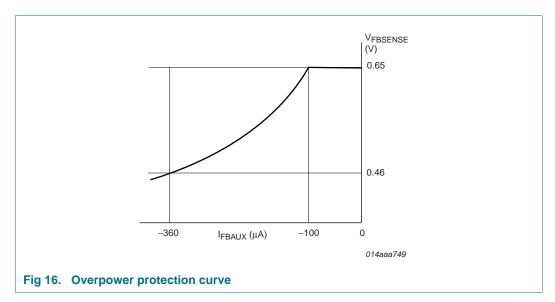


7.3.10 Overpower protection

During the primary stroke of the flyback converter, the input voltage is measured by sensing the current that is drawn from the FBAUX pin.

The current information is used to limit the maximum peak current of the flyback converter, measured from the FBSENSE pin. The internal compensation is such, that a maximum output power is realized which is almost independent of the input voltage.

The OPP curve is given in Figure 16.



7.3.11 Driver (FBDRIVER pin)

The driver circuit to the power MOSFET gate has a current sourcing capability of -500 mA and a current sink capability of 1.2 A. These capabilities permit fast switching of the power MOSFET for efficient operation.

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8. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
Voltages					
V _{CC}	supply voltage		-0.4	+38	V
V _{LATCH}	voltage on the LATCH pin	current limited	-0.4	+5	V
V _{FBCTRL}	voltage on the FBCTRL pin		-0.4	+5	V
V _{PFCCOMP}	voltage on the PFCCOMP pin		-0.4	+5	V
V _{VINSENSE}	voltage on the VINSENSE pin		-0.4	+5	V
V _{VOSENSE}	voltage on the VOSENSE pin		-0.4	+5	V
V _{PFCAUX}	voltage on the PFCAUX pin		-25	+25	V
V _{FBSENSE}	voltage on the FBSENSE pin	current limited	-0.4	+5	V
V _{PFCSENSE}	voltage on the PFCSENSE pin	current limited	-0.4	+5	V
V _{PFCTIMER}	voltage on the PFCTIMER pin		-0.4	+5.5	V
V _{HV}	voltage on the HV pin		-0.4	+650	V
Currents					
I _{FBCTRL}	current on the FBCTRL pin		-3	0	mA
I _{FBAUX}	current on the FBAUX pin		-1	+1	mA
IPFCSENSE	current on the PFCSENSE pin		-1	+10	mA
IFBSENSE	current on the FBSENSE pin		-1	+10	mA
I _{FBDRIVER}	current on the FBDRIVER pin	duty cycle < 10 %	-0.8	+2	А
IPFCDRIVER	current on the PFCDRIVER pin	duty cycle < 10 %	-0.8	+2	A
I _{HV} General	current on the HV pin		-	8	mA
P _{tot}	total power dissipation	T _{amb} < 75 ℃	-	0.6	W
T _{stg}	storage temperature		-55	+150	°C
T _j ESD	junction temperature		-40	+150	°C
V _{ESD}	electrostatic discharge	class 1			
	voltage	human body model			
		pins 1 to 13	<u>[1]</u> -	2000	V
		pin 16 (HV)	<u>[1]</u> _	1500	V
		machine model	[2] _	200	V
		charged device model	-	500	V

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- [1] Equivalent to discharging a 100 pF capacitor through a 1.5 k Ω series resistor.
- [2] Equivalent to discharging a 200 pF capacitor through a 0.75 μH coil and a 10 Ω resistor.

9. Thermal characteristics

Table 4.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air; JEDEC test board	124	K/W
R _{th(j-c)}	thermal resistance from junction to case	in free air; JEDEC test board	37	K/W

10. Characteristics

Table 5.Characteristics

 $T_{amb} = 25 \text{ °C}$; $V_{CC} = 20 \text{ V}$; all voltages are measured with respect to ground; currents are positive when flowing into the IC; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Start-up current s	source (HV pin)					
I _{HV}	current on the HV pin	V _{HV} > 80 V				
		V _{CC} < V _{trip} ; V _{th(UVLO)} < V _{CC} < V _{startup}	-	1.0	-	mA
		$V_{trip} < V_{CC} < V_{th(UVLO)}$	-	5.4	-	mA
		with auxiliary supply	8	20	40	μA
		in Power-down mode	5	16	20	μΑ
V _{BR}	breakdown voltage		650	-	-	V
Supply voltage m	anagement (V _{CC} pin)					
V _{trip}	trip voltage		0.55	0.65	0.75	V
V _{startup}	start-up voltage		21	22	23	V
V _{th(UVLO)}	undervoltage lockout threshold voltage		14	15	16	V
V _{start(hys)}	hysteresis of start voltage	during start-up phase	-	300	-	mV
V _{hys}	hysteresis voltage	$V_{startup} - V_{th(UVLO)}$	6.3	7	7.7	V
I _{ch(low)}	low charging current	V_{HV} > 80 V; V_{CC} < V_{trip} or $V_{th(UVLO)}$ < V_{CC} < $V_{startup}$	-1.2	-1.0	-0.8	mA
I _{ch(high)}	high charging current	V_{HV} > 80 V; V_{trip} < V_{CC} < $V_{th(UVLO)}$	-4.6	-5.4	-6.3	mA
I _{CC(oper)}	operating supply current	no load on the FBDRIVER and PFCDRIVER pins	2.25	3	3.75	mA
Input Voltage Ser	sing PFC (VINSENSE pin)					
$V_{stop(VINSENSE)}$	stop voltage on the VINSENSE pin		0.85	0.88	0.91	V
V _{start(VINSENSE)}	start voltage on the VINSENSE pin		1.11	1.15	1.19	V
$V_{mvc(VINSENSE)max}$	maximum mains voltage compensation voltage on the VINSENSE pin		4	-	-	V
V _{flr}	fast latch reset voltage	active after $V_{th(\text{UVLO})}$ is detected	-	0.75	-	V
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Table 5. Characteristics ...continued

 $T_{amb} = 25$ °C; $V_{CC} = 20$ V; all voltages are measured with respect to ground; currents are positive when flowing into the IC; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{flr(hys)}	hysteresis of fast latch reset voltage		-	0.12	-	V
I(VINSENSE)	input current on the VINSENSE pin	V _{VINSENSE} > V _{stop(VINSENSE)} after V _{start(VINSENSE)} is detected	5	33	100	nA
V _{bst(dual)}	dual boost voltage	current switch-over point	-	2.2	-	V
		switch-over region	-	200	-	mV
V _{th(pd)}	power-down threshold voltage		305	355	405	mV
V _{hys(pd)}	power-down hysteresis voltage		55	85	120	mV
	ion PFC (PFCCOMP pin)					
9 _m	transconductance	V _{VOSENSE} to I _{O(PFCCOMP)}	60	80	100	μΑ/\
I _{O(PFCCOMP)}	output current on the	$V_{VOSENSE} = 2 V$	33	39	45	μΑ
, , , , , , , , , , , , , , , , , , ,	PFCCOMP pin	V _{VOSENSE} = 3.3 V	-45	-39	-33	μA
V _{en(PFCCOMP)}	enable voltage on the	VINSENSE ≥ V _{bst(dual)}		3.5		V
	PFCCOMP pin	VINSENSE < V _{bst(dual)}		2.5		V
V _{clamp} (PFCCOMP)	clamp voltage on the PFCCOMP pin	Low-power mode; PFC off; lower clamp voltage.	<u>[1]</u>			
		VINSENSE ≥ V _{bst(dual)}	-	3.5	-	V
		VINSENSE < V _{bst(dual)}	-	2.5	-	V
		Upper clamp voltage	-	3.9	-	V
Vton(PFCCOMP)zero	zero on-time voltage on the PFCCOMP pin		3.4	3.5	3.6	V
V _{ton} (PFCCOMP)max	maximum on-time voltage the pin PFCCOMP pin		1.20	1.25	1.30	V
Pulse width mod	ulator PFC					
t _{on(PFC)}	PFC on-time	$V_{VINSENSE} = 3.3 V;$ $V_{PFCCOMP} = V_{ton(PFCCOMP)max}$	3.6	4.5	5	μS
		$V_{VINSENSE} = 0.9 V;$ $V_{PFCCOMP} = V_{ton(PFCCOMP)max}$	30	40	53	μS
Output voltage se	ensing PFC (VOSENSE pin)					
$V_{th(ol)(VOSENSE)}$	open-loop threshold voltage on the VOSENSE pin		-	1.15	-	V
V _{reg(VOSENSE)}	regulation voltage on the VOSENSE pin	for $I_{O(PFCCOMP)} = 0$	2.475	2.500	2.525	V
Vovp(VOSENSE)	overvoltage protection voltage on the VOSENSE pin		2.60	2.63	2.67	V
l _{bst(dual)}	dual boost current	V _{VINSENSE} < V _{bst(dual)} or V _{VOSENSE} < 2.1 V	-	-8	-	μA
		V _{VINSENSE} > V _{bst(dual)}	-	-30	-	nA
Over current pro	tection PFC (PFCSENSE pin)					
V _{sense} (PFC)max	maximum PFC sense voltage	$\Delta V/\Delta t = 50 \text{ mV}/\mu s$	0.49	0.52	0.55	V
		$\Delta V / \Delta t = 200 \text{ mV} / \mu \text{s}$	0.51	0.54	0.57	V
t _{leb(PFC)}	PFC leading edge blanking time		250	310	370	ns
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Table 5. Characteristics ...continued

 $T_{amb} = 25$ °C; $V_{CC} = 20$ V; all voltages are measured with respect to ground; currents are positive when flowing into the IC; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
prot(PFCSENSE)	protection current on the PFCSENSE pin			-50	-	-5	nA
Soft-start PFC (P	FCSENSE pin)						
I _{start(soft)PFC}	PFC soft-start current			-75	-60	-45	μA
V _{start(soft)PFC}	PFC soft-start voltage	enabling voltage		0.46	0.50	0.54	V
V _{stop(soft)PFC}	PFC soft-stop voltage	disabling voltage		0.42	0.45	0.48	V
Oscillator PFC							
f _{sw(PFC)max}	maximum PFC switching frequency			-	250	-	kHz
t _{off(PFC)min}	minimum PFC off-time			0.8	1.1	1.4	μS
Valley switching	PFC (PFCAUX pin)						
$(\Delta V/\Delta t)_{vrec(PFC)}$	PFC valley recognition voltage change with time			-	-	1.7	V/µs
t _{vrec(PFC)}	PFC valley recognition time	V _{PFCAUX} = 1 V peak to peak	[2]	-	-	300	ns
		demagnetization to $\Delta V/\Delta t = 0$	[3]	-	-	50	ns
t _{to(vrec)} PFC	PFC valley recognition time-out time			3	4	6	μS
Demagnetization	management PFC (PFCAUX pi	n)					
$V_{th(comp)}$ PFCAUX	comparator threshold voltage on the PFCAUX pin			-150	-100	-50	mV
t _{to(demag)} PFC	PFC demagnetization time-out time			40	50	60	μS
I _{prot(PFCAUX)}	protection current on the PFCAUX pin	V _{PFCAUX} = 50 mV		-75	-	-5	nA
PFC off delay (PF	CTIMER pin)						
I _{source} (PFCTIMER)	source current on the PFCTIMER pin			-	-5	-	μA
I _{sink(PFCTIMER)}	sink current on the PFCTIMER pin	V _{PFCTIMER} = 5 V		-	3.5	-	mA
V _{start(PFCTIMER)}	start voltage on the PFCTIMER pin			-	1.27	-	V
$V_{stop(PFCTIMER)}$	stop voltage on the PFCTIMER pin			-	3.6	-	V
Driver (PFCDRIV	ER pin)						
Isrc(PFCDRIVER)	source current on the PFCDRIVER pin	V _{PFCDRIVER} = 2 V		-	-0.5	-	A
Isink(PFCDRIVER)	sink current on the	V _{PFCDRIVER} = 2 V		-	0.7	-	А
	PFCDRIVER pin	V _{PFCDRIVER} = 10 V		-	1.2	-	А
V _O (PFCDRIVER)max	maximum output voltage on the PFCDRIVER pin			9.5	10.8	12	V
OverVoltage Prot	ection flyback (FBAUX pin)						
I _{ovp(FBAUX)}	overvoltage protection current			279	300	321	μA

HV start-up flyback controller with integrated PFC controller

Table 5. Characteristics ...continued

 $T_{amb} = 25 \text{ °C}$; $V_{CC} = 20 \text{ V}$; all voltages are measured with respect to ground; currents are positive when flowing into the IC; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
N _{cy(ovp)}	number of overvoltage protection cycles			6	8	12	
Demagnetization	management flyback (FBAUX	pin)					
$V_{th(comp)}FBAUX$	comparator threshold voltage on the FBAUX pin			60	80	110	mV
I _{prot(FBAUX)}	protection current on the FBAUX pin	V _{FBAUX} = 50 mV		-75	-	-5	nA
V _{clamp(FBAUX)}	clamp voltage on the FBAUX	$I_{FBAUX} = -100 \ \mu A$		-0.85	-0.7	-0.55	V
	pin	I _{FBAUX} = 300 μA		0.79	0.94	1.09	V
t _{sup(xfmr_ring)}	transformer ringing suppression time			1.5	2	2.5	μS
Pulse width mod	ulator flyback						
t _{on(fb)min}	minimum flyback on-time			-	t _{leb}	-	ns
t _{on(fb)max}	maximum flyback on-time			32	40	48	μS
Oscillator flybac	k						
f _{sw(fb)max}	maximum flyback switching frequency			100	125	150	kHz
V _{start(VCO)} FBCTRL	VCO start voltage on the FBCTRL pin			1.3	1.5	1.7	V
f _{sw(fb)swon(PFC)}	PFC switch-on flyback switching frequency			-	86	-	kHz
f _{sw(fb)swoff} (PFC)	PFC switch-off flyback switching frequency			-	48	-	kHz
$\Delta V_{VCO(FBCTRL)}$	VCO voltage difference on the FBCTRL pin			-	-0.12	-	V
Peak current con	trol flyback (FBCTRL pin)						
V _{FBCTRL}	voltage on the FBCTRL pin	for maximum flyback peak current		1.85	2	2.15	V
V _{to(FBCTRL)}	time-out voltage on the	enable voltage		-	2.5	-	V
	FBCTRL pin	trip voltage		4.2	4.5	4.8	V
R _{int(FBCTRL)}	internal resistance on the FBCTRL pin			-	3	-	kΩ
I _{O(FBCTRL)}	output current on the FBCTRL	V _{FBCTRL} = 0 V		-1.4	-1.19	-0.93	mA
	pin	V _{FBCTRL} = 2 V		-0.6	-0.5	-0.4	mA
I _{to(FBCTRL)}	time-out current on the	V _{FBCTRL} = 2.6 V		-36	-30	-24	μΑ
	FBCTRL pin	V _{FBCTRL} = 4.1 V		-34.5	-28.5	-22.5	μΑ
Valley switching	flyback (HV pin)						
$(\Delta V / \Delta t)_{vrec(fb)}$	flyback valley recognition voltage change with time			-75	-	+75	V/µ
t _{d(vrec-swon)}	valley recognition to switch on delay time		<u>[4]</u>	-	150	-	ns
Soft-start flyback							
I _{start(soft)fb}	flyback soft-start current			-75	-60	-45	μA
V _{start(soft)fb}	flyback soft-start voltage	enable voltage		0.55	0.63	0.70	V
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HV start-up flyback controller with integrated PFC controller

Table 5. Characteristics ...continued

 $T_{amb} = 25 \text{ °C}$; $V_{CC} = 20 \text{ V}$; all voltages are measured with respect to ground; currents are positive when flowing into the IC; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Uni
Overcurrent prot	ection flyback (FBSENSE pin)					
V _{sense(fb)max}	maximum flyback sense voltage	$\Delta V/\Delta t = 50 \text{ mV}/\mu s$	0.61	0.65	0.69	V
		$\Delta V/\Delta t = 200 \text{ mV}/\mu s$	0.64	0.68	0.72	
V _{sense(fb)} min	minimum flyback sense voltage	$\Delta V/\Delta t = 50 \text{ mV/}\mu s$	0.305	0.325	0.345	V
t _{leb(fb)}	flyback leading-edge blanking time		255	305	355	ns
adj(FBSENSE)	adjust current on the FBSENSE pin		-3.2	-3	-2.8	μA
Overpower prote	ection flyback (FBSENSE pin)					
V _{sense(fb)max}	maximum flyback sense	$\Delta V/\Delta t = 50 \text{ mV/}\mu s$				
	voltage	I _{FBAUX} = 80 μA	0.61	0.65	0.69	V
		I _{FBAUX} = 120 μA	0.57	0.62	0.67	V
		I _{FBAUX} = 240 μA	0.47	0.52	0.57	V
		I _{FBAUX} = 360 μA	0.41	0.46	0.51	V
Driver (FBDRIVE	R pin)					
src(FBDRIVER)	source current on the FBDRIVER pin	$V_{FBDRIVER} = 2 V$	-	-0.5	-	A
Isink(FBDRIVER)	sink current on the FBDRIVER pin	V _{FBDRIVER} = 2 V	-	0.7	-	А
		V _{FBDRIVER} = 10 V	-	1.2	-	А
V _{O(FBDRIVER)(max)}	maximum output voltage on the FBDRIVER pin		9.5	10.8	12	V
LATCH input (LA	TCH pin)					
V _{prot(LATCH)}	protection voltage on the LATCH pin		1.23	1.25	1.27	V
I _{O(LATCH)}	output current on the LATCH pin	$V_{prot(LATCH)} < V_{LATCH} < V_{oc(LATCH)}$	-85	-80	-75	μA
V _{en(LATCH)}	enable voltage on the LATCH pin	at start-up	1.30	1.35	1.40	V
V _{hys(LATCH)}	hysteresis voltage on the LATCH pin	$V_{en(\text{LATCH})} - V_{prot(\text{LATCH})}$	80	100	140	mV
V _{oc(LATCH)}	open-circuit voltage on the LATCH pin		2.65	2.9	3.15	V
Temperature pro	tection					
T _{pl(IC)}	IC protection level temperature		130	140	150	°C
T _{pl(IC)hys}	hysteresis of IC protection level		-	10	-	°C

[1] For a typical application with a compensation network on pin PFCCOMP, like the example in Figure 3.

[2] Minimum required voltage change time for valley recognition on pin PFCAUX.

[3] Minimum time required between demagnetization detection and $\Delta V/\Delta t = 0$ on pin PFCAUX.

[4] Guaranteed by design.

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11. Application information

A power supply with the TEA1753LT consists of a power factor correction circuit and a flyback converter. See Figure 17.

Capacitor C_{VCC} buffers the IC supply voltage. The IC is powered from the high voltage rectified mains during start-up and the auxiliary winding of the flyback converter during operation. Sense resistors R_{SENSE1} and R_{SENSE2} convert the current through the MOSFETs S1 and S2 into a voltage at the PFCSENSE and FBSENSE pins. The values of R_{SENSE1} and R_{SENSE2} define the maximum primary peak current in MOSFETs S1 and S2.

In the example given, the LATCH pin is connected to a Negative Temperature Coefficient (NTC) resistor. The protection is activated when the resistance drops below a value calculated as follows:

$$\frac{V_{prot(LATCH)}}{I_{O(LATCH)}} = 15.6 \text{ k}\Omega$$

(8)

A capacitor $C_{TIMEOUT}$ is connected to the FBCTRL pin. For a 120 nF capacitor, the time-out protection is activated after 10 ms. R_{LOOP} is added so that the time-out capacitor does not interfere with the normal regulation loop.

 R_{S1} and R_{S2} are added to prevent the soft-start capacitors from being charged during normal operation due to negative voltage spikes across the sense resistors.

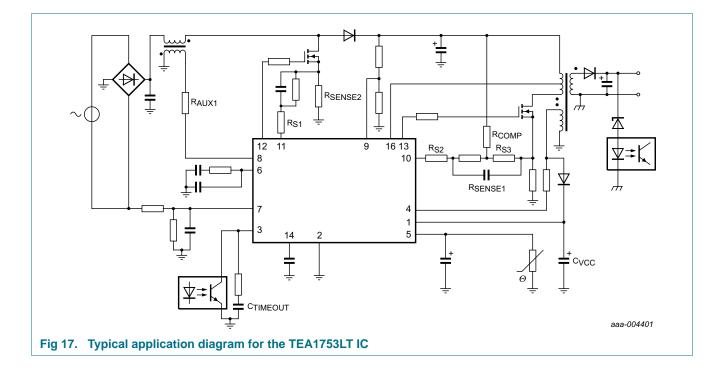
Resistor R_{AUX1} is added to protect the IC from damage during lightning events.

RS3 and RCOMP are added to compensate for input voltage variations. The (stray) capacitance on the drain node of MOSFET S3 affects the frequency reduction slope and therefore the PFC switch-on and switch-off levels. Choosing the proper values for RS3 and RCOMP results in an input voltage independent PFC switch-on and switch-off power level.

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12. Package outline

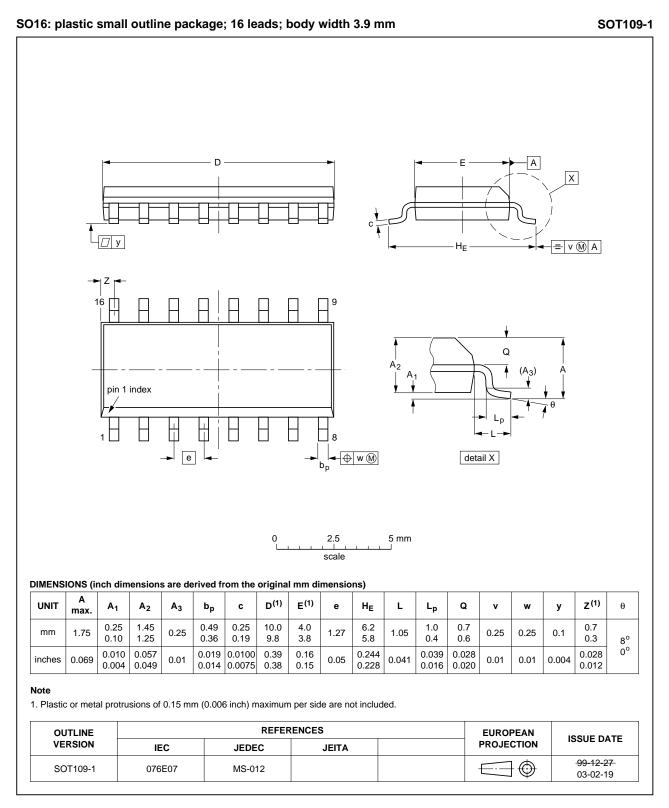


Fig 18. Package outline SOT109-1 (SO16)

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13. Revision history

Table 6. Revision	history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
TEA1753LT v.3	20120824	Product data sheet		TEA1753LT v.2
Modifications:	 Multiple tex 	t changes		
	 Multiple gra 	phic updates		
	 Updates to 	several characteristics		
TEA1753LT v.2	20110408	Product data sheet	-	TEA1753LT v.1
TEA1753LT v.1	20110304	Objective data sheet	-	-

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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NXP Semiconductors

TEA1753LT

HV start-up flyback controller with integrated PFC controller

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